

B RH

CRYSTAL SPECIFICATION

Customer	:		
Customer P/N	:		
Agent	-		
Agent Code	:		
SIWARD P/N	:	XTL571100-H201-493	

Customer Approval :

希華晶體科技股份有限公司 SIWARD CRYSTAL TECHNOLOGY CO., LTD.

業務部/ SALE DEPARTMENT DATE TEL: (04)25347909 FAX: (04)25327885 / 25337396 URL HTTP://www.siward.com.tw 品質保證部/ QUALITY ASSURANCE DEPT. TEL: (04)25347909 EXT 1340/1341 Checked By 研發部/R & D DEPT.

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2014/04/01 ·

Approved By

Designer

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Rev.	Description of Revision History	Date	Designer	Checked B
1	New Publication	2014/01/28	Sally Lin	Tom Tang



CRYSTAL SPECIFICATION

1.	Description	:	Quartz Crystal
2.	Nominal Frequency	:	25.000000 MHz
3.	Center Frequency	:	25.000000 MHz
4.	Dimension & Drawing No.	:	SX-3225 ; SXD-00306
5.	Oscillation Mode	:	Fundamental
6.	Cutting Mode	:	AT cut
7.	Packing Style	:	TP-167
8.	Measurement Instrument	:	S&A 250B(Measured FL)

:

9. Electrical Characteristics [1] Operating Conditions :

Item	Symbol	MIN.	TYP.	MAX.	Unit	Condition
Operating Temperature Range	Topt	-20		70	°C	
Storage Temperature Range	Tstg	-40		90	°C	
Load Capacitance	CL		12		pF	
Drive Level	DL			100	μW	

[2] Frequency Stability :

Item	Symbol	MIN.	TYP.	MAX.	Unit	Condition
Tolerance	dF/Fo	-10		10	ppm	Refer to Center Frequency @25±3°C
Stability Over Temperature	dF/F25	-10		10	ppm	Refer to Operating Temperature
Aging	dF/F25	-2		2	ppm	Per Year

dF/Fo: Frequency Deviation Refer to Center Frequency

dF/F25: Frequency Deviation Refer to 25 $^\circ\!\mathrm{C}$ Frequency



[3] Electrical Performance :

Item	Symbol	MIN.	TYP.	MAX.	Unit	Condition
Equivalent Series Resistance	ESR			60	Ω	@Series
Shunt Capacitance	C0			5	pF	
Insulation Resistance	IR	500			MΩ	@DC 100 Volt

10. Marking : Laser

*MARKING : D ->YEAR C -> MONTH	
YEAR : 1 2 3 4 5 6 7 8 9 0	25.0
CODE : A B C D E F G H J K MONTH: 1 2 3 4 5 6 7 8 9 10 11 12	S DC
CODE : A B C D E F G H J K L M	

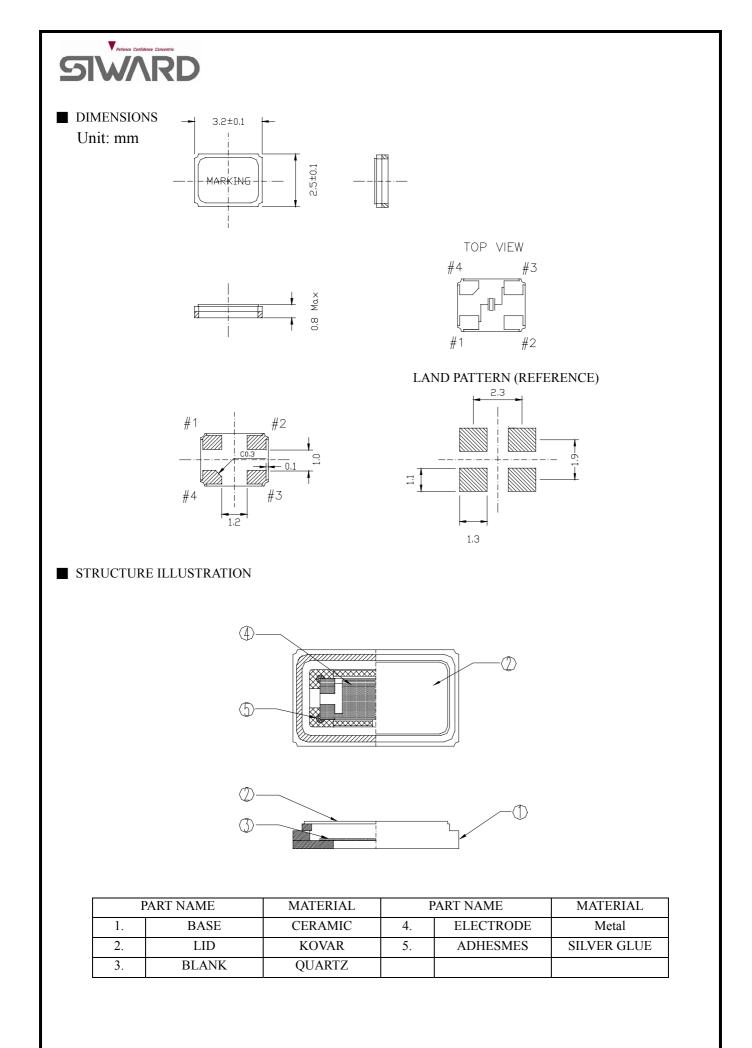
11. Remark :

* Compliant with RoHS and Siward QAD-S-116 Standard.

■Note

1.General cleaning solutions or ultrasonic cleaning method may be used to clean our products. However, under certain circumstances, ultrasonic cleaning machine could generate resonance at the oscillaton frequency of our products and thus deteriorate the electrical characteristics in devices, and even damage the overall structure of devices. Therefore, verification test is recommended before cleaning.

2. Avoid mounting and processing by Ultrasonic welding this method has a possibility of an excessive vibration spreading inside the crystal products and becoming the cause of characteristic deterioration and not oscillating.





RELIABILITY SPECIFICATION

REFER TO JIS C 6701

1. ENVIRONMENTAL PERFORMANCE

ITEM	CONDITION
1. HIGH TEMPERATURE	STORED AT 85±2°C FOR 720±12H. (If Customer's temperature request
STORAGE	is higher than the standard, Temperature test must be done for customer
	requirements.)
	THEN $25\pm2^{\circ}$ OVER 2H BEFORE TESTING.
2. LOW TEMPERATURE	STORED AT $-40\pm2^{\circ}$ C FOR 500 ±12 H. (If Customer's temperature request
STORAGE	is lower than the standard, Temperature test must be done for customer
	requirements.)
	THEN $25\pm2^{\circ}$ OVER 2H BEFORE TESTING.
3. HIGH TEMP. & HUMIDITY	STORED AT $60\pm 2^{\circ}$ C AND HUMIDITY $90 \sim 95\%$ For 500 ± 12 H.
	THEN $25\pm2^{\circ}$ OVER 2H BEFORE TESTING.
4. TEMPERATURE CYCLE	THE CRYSTAL UNIT SHALL BE SUBJECTED TO 100 SUCCESSIVE
	CHANGE OF TEMPERATURE CYCLES, THEN 25 $\pm 2^{\circ}$ C OVER 2 H
	BEFORE TESTING, EACH CYCLE AS BELLOW :
	TEMPERATURE DURATION
	140+0/-6°C 30±3 MINUTES
	2. $25^{\circ}C \pm 2^{\circ}C$ 2~3 MINUTES
	3. $85+4/-0^{\circ}$ C 30 ±3 MINUTES
	4. $25^{\circ}C \pm 2^{\circ}C$ 2~3 MINUTES

2. MECHANICAL PERFORMANCE

ITEM	CONDITION
5. SOLDERABILITY	THE LEAD IS IMMERSED IN A 260±5°C SOLDER BATH WITHIN
	2±0.6 SECONDS.
6. RESISTANCE TO	REFLOW CHART AS ATTACH SHEET. TWICE PASS.
SOLDERING HEAT	
7. FREE FALL	FREE DROPPING FROM 75 cm HEIGHT 3 TIMES ON A HARD
	WOODEN BOARD.
8. VIBRATION	FREQUENCY : $10 \sim 55$ Hz,
	AMPLITUDE (TOTAL EXCURSION) : 1.5mm±15%,
	SWEEP TIME : 1MIN, 3 DIRECTION(X, Y, Z) EACH FOR 2 Hrs.
9. GROSS LEAK	STANDARD SAMPLE FOR AUTOMATIC GROSS LEAK DETECTOR,
	TEST PRESSURE: 0.2 Mpa
10. FINE LEAK	HELIUM BOMBING $5.0 \sim 5.5 \text{ Kgf} / \text{ cm}^2$
	FOR 2 HOURS.

11. TERMINAL STRENGTH	SHALL BE PRESSURIZED AT A SPEED OF APPROX.0.5mm/sec IN
	THE DIRECTION INDICATED BY THE ARROW UNTIL THE
	BENDING WIDTH REACHES 3mm AND HELD FOR 5 SECONDS.
	PRESSURE ROD R20
	R5 AMPLE R5
	45±2 45±2
12. STICKING TENDENCY	A R0.5 JIG SHALL BE USED TO APPLY A 10N DEAD LOAD IN THE
	DIRECTION INDICATED BY THE ARROW TO THE ELEMENT AND
	RETAIN IT FOR 10 SECONDS.
	↓ SAMPLE
13. ELEMENT ASSEMBLY	A R0.5 PRESSURIZED BAR SHALL BE USED TO APPLY A 10N
13. ELEMENT ASSEMBLY STRENGTH	A R0.5 PRESSURIZED BAR SHALL BE USED TO APPLY A 10N LOAD IN THE CENTER OF ELEMENT AND RETAIN IT FOR 10

■ SUGGESTED REFLOW PROFILE

